



Fast IGBT in NPT-technology

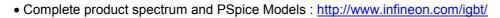
- 75% lower E_{off} compared to previous generation combined with low conduction losses
- \bullet Short circuit withstand time 10 μs



- Motor controls
- Inverter
- NPT-Technology for 600V applications offers:
 - very tight parameter distribution
 - high ruggedness, temperature stable behaviour
 - parallel switching capability







Туре	V _{CE}	Ic	V _{CE(sat)}	T _j	Marking	Package
SGB10N60A	600V	10A	2.3V	150°C	G10N60A	PG-TO-263-3-2

Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-emitter voltage	V _{CE}	600	V
DC collector current	Ic		Α
<i>T</i> _C = 25°C		20	
$T_{\rm C}$ = 100°C		10.6	
Pulsed collector current, t_p limited by T_{jmax}	I _{Cpuls}	40	
Turn off safe operating area	-	40	
$V_{CE} \le 600 \text{V}, \ T_{j} \le 150^{\circ}\text{C}$			
Gate-emitter voltage	V_{GE}	±20	V
Avalanche energy, single pulse	E _{AS}	70	mJ
$I_{\rm C}$ = 10 A, $V_{\rm CC}$ = 50 V, $R_{\rm GE}$ = 25 Ω ,			
start at $T_j = 25^{\circ}\text{C}$			
Short circuit withstand time ²	tsc	10	μs
$V_{\rm GE}$ = 15V, $V_{\rm CC} \le 600$ V, $T_{\rm j} \le 150$ °C			
Power dissipation	P _{tot}	92	W
<i>T</i> _C = 25°C			
Operating junction and storage temperature	$T_{\rm j}$, $T_{ m stg}$	-55+150	°C
Soldering temperature (reflow soldering MSL1)		245	

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¹ J-STD-020 and JESD-022

² Allowed number of short circuits: <1000; time between short circuits: >1s.





Thermal Resistance

Parameter	Symbol	Conditions	Max. Value	Unit
Characteristic				
IGBT thermal resistance,	R_{thJC}		1.35	K/W
junction – case				
Thermal resistance,	R_{thJA}		40	
junction – ambient ¹⁾				

Electrical Characteristic, at T_i = 25 °C, unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
Parameter	Symbol	Conditions	min.	Тур.	max.	Unit
Static Characteristic						•
Collector-emitter breakdown voltage	$V_{(BR)CES}$	$V_{\rm GE}$ =0V, $I_{\rm C}$ =500 μ A	600	-	-	V
Collector-emitter saturation voltage	$V_{CE(sat)}$	$V_{\rm GE} = 15 \rm V, I_{\rm C} = 10 \rm A$				
		<i>T</i> _j =25°C	1.7	2	2.4	
		T _j =150°C	-	2.3	2.8	
Gate-emitter threshold voltage	$V_{\rm GE(th)}$	$I_{\rm C} = 300 \mu A, V_{\rm CE} = V_{\rm GE}$	3	4	5	
Zero gate voltage collector current	I _{CES}	V _{CE} =600V, V _{GE} =0V				μΑ
		<i>T</i> _j =25°C	-	-	40	
		T _j =150°C	-	-	1500	
Gate-emitter leakage current	I _{GES}	$V_{CE} = 0 \text{ V}, V_{GE} = 20 \text{ V}$	-	-	100	nA
Transconductance	g_{fs}	$V_{\rm CE} = 20 \text{V}, I_{\rm C} = 10 \text{A}$	-	6.7	-	S
Dynamic Characteristic						
Input capacitance	Ciss	V _{CE} =25V,	1	550	660	pF
Output capacitance	Coss	$V_{GE}=0V$,	1	62	75	
Reverse transfer capacitance	Crss	<i>f</i> =1MHz	-	42	51	
Gate charge	Q _{Gate}	$V_{\rm CC}$ =480V, $I_{\rm C}$ =10A	-	52	68	nC
		V _{GE} =15V				
Internal emitter inductance	LE		-	7	-	nΗ
measured 5mm (0.197 in.) from case						
Short circuit collector current ²⁾	$I_{C(SC)}$	$V_{\text{GE}} = 15 \text{V}, t_{\text{SC}} \le 10 \mu \text{s}$ $V_{\text{CC}} \le 600 \text{V},$ $T_{\text{j}} \le 150 ^{\circ} \text{C}$	-	100	-	A

Device on 50mm*50mm*1.5mm epoxy PCB FR4 with 6cm² (one layer, 70μm thick) copper area for collector connection. PCB is vertical without blown air.
 Allowed number of short circuits: <1000; time between short circuits: >1s.





Switching Characteristic, Inductive Load, at T_j =25 $^{\circ}$ C

Parameter	Symbol	Conditions	Value			Unit
raidilletei	Symbol	Conditions	min.	typ.	max.	Joint
IGBT Characteristic						
Turn-on delay time	$t_{d(on)}$	<i>T</i> _j =25°C,	-	28	34	ns
Rise time	t_{r}	$V_{\rm CC}$ =400V, $I_{\rm C}$ =10A, $V_{\rm GE}$ =0/15V, $R_{\rm G}$ =25 Ω , $L_{\sigma}^{1)}$ =180nH, $C_{\sigma}^{1)}$ =55pF	ı	12	15	
Turn-off delay time	$t_{d(off)}$		ı	178	214	
Fall time	t_{f}		-	24	29	
Turn-on energy	Eon		-	0.15	0.173	mJ
Turn-off energy	E_{off}	Energy losses include "tail" and diode	ı	0.17	0.221	
Total switching energy	E_{ts}	reverse recovery.	-	0.320	0.394	

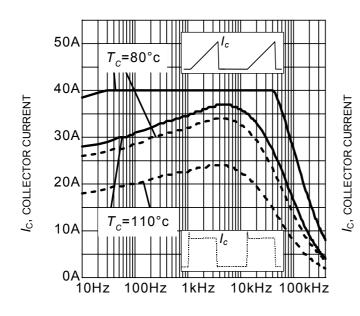
Switching Characteristic, Inductive Load, at T_i =150 °C

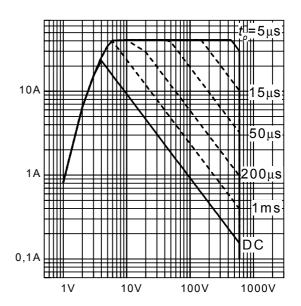
Parameter	Symbol	Conditions	Value			Unit
Parameter	Symbol	Conditions	min.	typ.	max.	Unit
IGBT Characteristic						
Turn-on delay time	$t_{d(on)}$	T _j =150°C	-	28	34	ns
Rise time	t _r	$V_{CC}=400V, I_{C}=10A,$ $V_{GE}=0/15V,$ $R_{G}=25\Omega$ $L_{\sigma}^{1)}=180nH,$ $C_{\sigma}^{1)}=55pF$	-	12	15	
Turn-off delay time	$t_{d(off)}$		-	198	238	
Fall time	t _f		-	26	32	
Turn-on energy	Eon		-	0.260	0.299	mJ
Turn-off energy	E _{off}	Energy losses include	-	0.280	0.364	
Total switching energy	E _{ts}	- "tail" and diode reverse recovery.	-	0.540	0.663	

 $^{^{1)}}$ Leakage inductance L $_{\sigma}$ and Stray capacity C $_{\sigma}$ due to dynamic test circuit in Figure E.









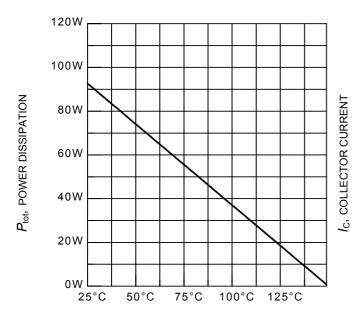
f, SWITCHING FREQUENCY

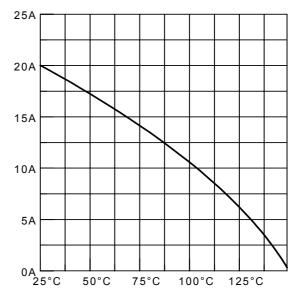
Figure 1. Collector current as a function of switching frequency

 $(T_{\rm j} \le 150^{\circ}\text{C}, D = 0.5, V_{\rm CE} = 400\text{V}, V_{\rm GE} = 0/+15\text{V}, R_{\rm G} = 25\Omega)$

 $V_{\rm CE}$, COLLECTOR-EMITTER VOLTAGE

Figure 2. Safe operating area $(D = 0, T_C = 25^{\circ}C, T_i \le 150^{\circ}C)$





 $T_{\rm C}$, CASE TEMPERATURE

Figure 3. Power dissipation as a function of case temperature

 $(T_i \le 150^{\circ}C)$

 $T_{
m C}$, CASE TEMPERATURE

Figure 4. Collector current as a function of case temperature

 $(V_{GE} \le 15V, T_{j} \le 150^{\circ}C)$





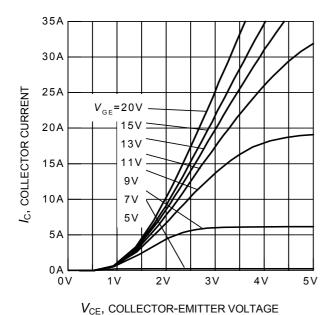
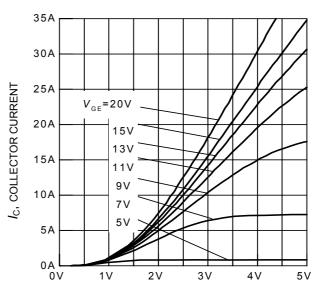
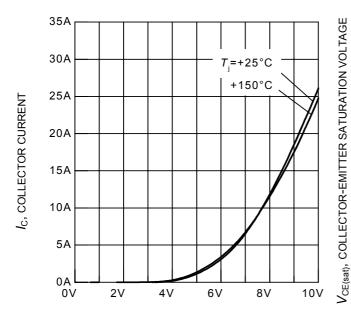


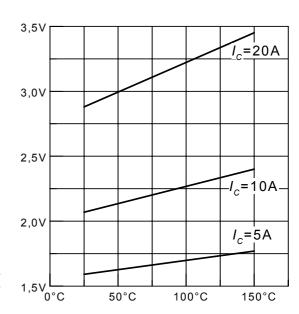
Figure 5. Typical output characteristics $(T_i = 25^{\circ}\text{C})$



 $V_{\rm CE}$, COLLECTOR-EMITTER VOLTAGE Figure 6. Typical output characteristics ($T_{\rm i}$ = 150°C)



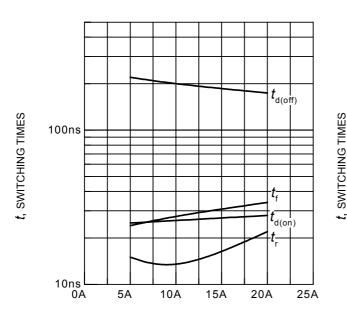
 $V_{\rm GE}$, GATE-EMITTER VOLTAGE Figure 7. Typical transfer characteristics ($V_{\rm CE}$ = 10V)



 $T_{\rm j}$, JUNCTION TEMPERATURE Figure 8. Typical collector-emitter saturation voltage as a function of junction temperature ($V_{\rm GE}$ = 15V)







100ns $t_{d(off)}$ t_{f} $t_{d(on)}$ t_{r} t_{r}

 $I_{\rm C}$, COLLECTOR CURRENT

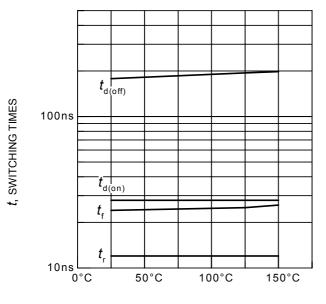
Figure 9. Typical switching times as a function of collector current (inductive load, $T = 150^{\circ}$ C, $V_{00} = 400$ V

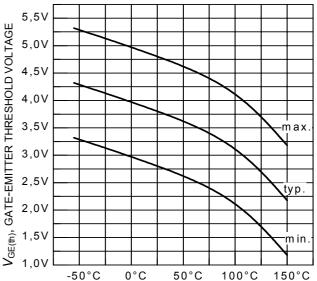
(inductive load, $T_{\rm j}$ = 150°C, $V_{\rm CE}$ = 400V, $V_{\rm GE}$ = 0/+15V, $R_{\rm G}$ = 25 Ω , Dynamic test circuit in Figure E)

 R_{G} , GATE RESISTOR

Figure 10. Typical switching times as a function of gate resistor

(inductive load, $T_{\rm j}$ = 150°C, $V_{\rm CE}$ = 400V, $V_{\rm GE}$ = 0/+15V, $I_{\rm C}$ = 10A, Dynamic test circuit in Figure E)





 $T_{\rm i}$, JUNCTION TEMPERATURE

Figure 11. Typical switching times as a function of junction temperature

(inductive load, $V_{\rm CE}$ = 400V, $V_{\rm GE}$ = 0/+15V, $I_{\rm C}$ = 10A, $R_{\rm G}$ = 25 Ω ,

Dynamic test circuit in Figure E)

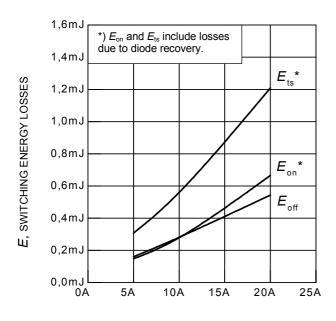
 $T_{\rm i}$, JUNCTION TEMPERATURE

Figure 12. Gate-emitter threshold voltage as a function of junction temperature

 $(I_{\rm C} = 0.3 {\rm mA})$



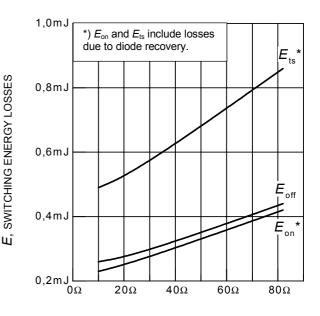




 $I_{\rm C}$, COLLECTOR CURRENT

Figure 13. Typical switching energy losses as a function of collector current (inductive load, $T_i = 150^{\circ}\text{C}$, $V_{\text{CE}} = 400\text{V}$,

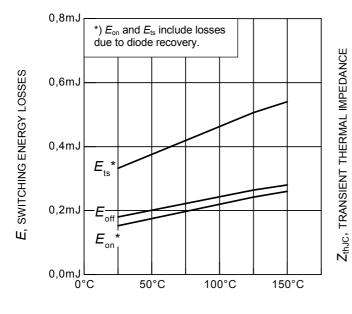
 $V_{\rm GE} = 0/+15 \text{V}, R_{\rm G} = 25 \Omega,$ Dynamic test circuit in Figure E)



R_G, GATE RESISTOR

Figure 14. Typical switching energy losses as a function of gate resistor

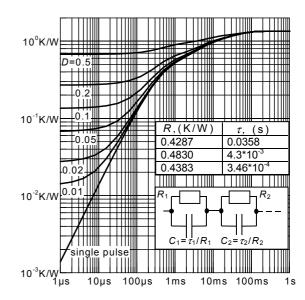
(inductive load, $T_j = 150$ °C, $V_{CE} = 400$ V, $V_{GE} = 0/+15V$, $I_{C} = 10A$, Dynamic test circuit in Figure E)



 $T_{\rm i}$, JUNCTION TEMPERATURE

Figure 15. Typical switching energy losses as a function of junction temperature (inductive load, $V_{CE} = 400V$, $V_{GE} = 0/+15V$,

 $I_{\rm C}$ = 10A, $R_{\rm G}$ = 25 Ω , Dynamic test circuit in Figure E)



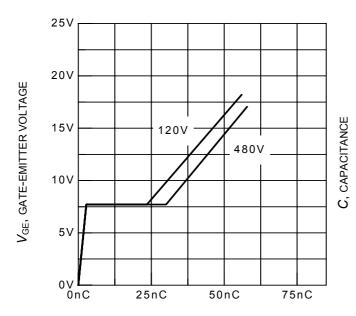
 $t_{\rm p}$, PULSE WIDTH

Figure 16. IGBT transient thermal impedance as a function of pulse width

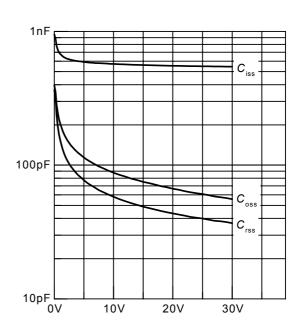
 $(D = t_D / T)$







 $$Q_{\rm GE},\,{\rm GATE}\,{\rm CHARGE}$$ Figure 17. Typical gate charge (/c = 10A)



 $V_{\rm CE}$, COLLECTOR-EMITTER VOLTAGE Figure 18. Typical capacitance as a function of collector-emitter voltage ($V_{\rm GE}$ = 0V, f = 1MHz)

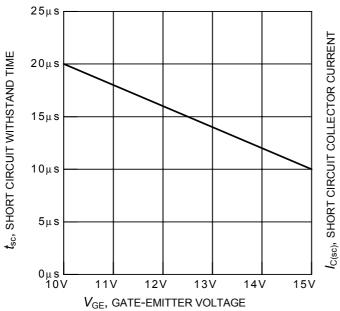


Figure 19. Short circuit withstand time as a function of gate-emitter voltage ($V_{CE} = 600V$, start at $T_i = 25^{\circ}C$)

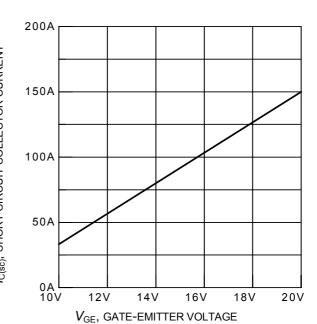
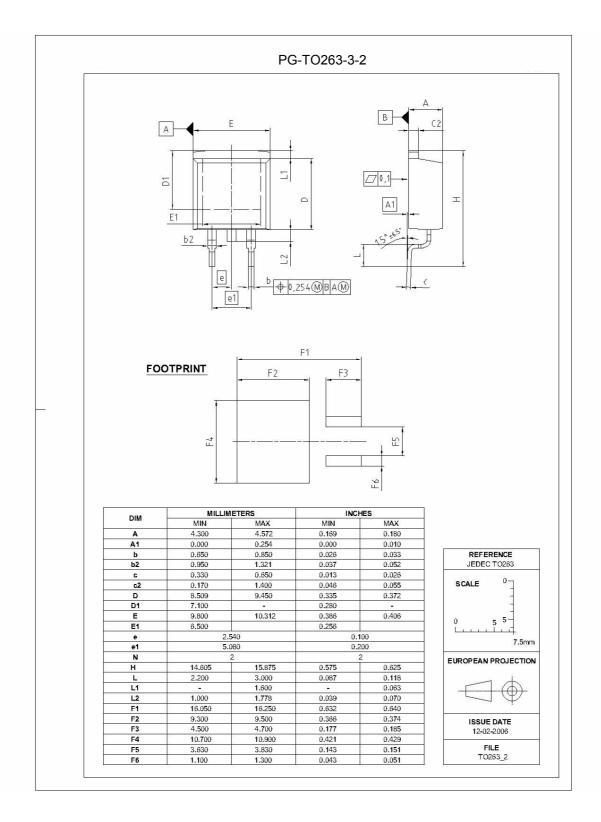


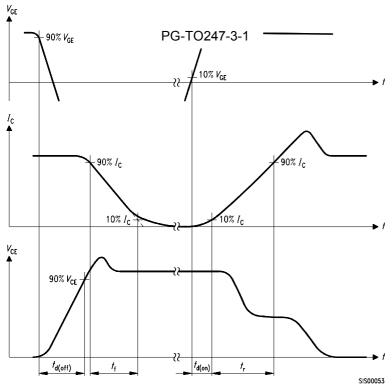
Figure 20. Typical short circuit collector current as a function of gate-emitter voltage ($V_{CE} \le 600V$, $T_i = 150^{\circ}C$)











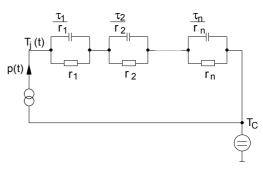


Figure D. Thermal equivalent circuit

Figure A. Definition of switching times

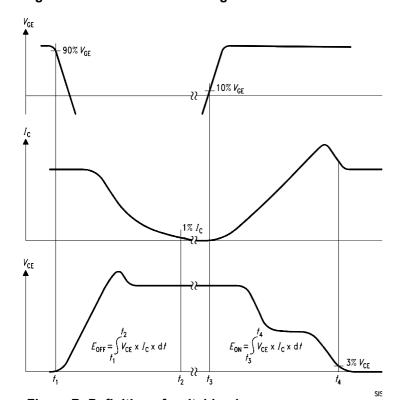


Figure B. Definition of switching losses

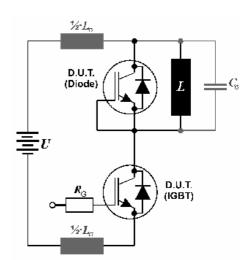


Figure E. Dynamic test circuit Leakage inductance L_{σ} =180nH and Stray capacity C_{σ} =55pF.

SGB10N60A



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